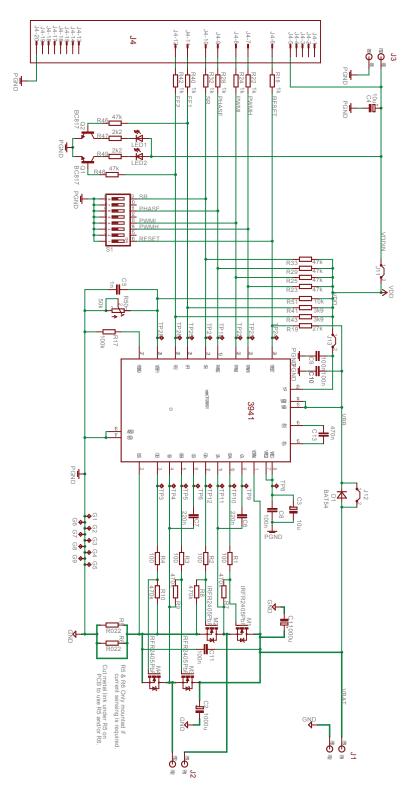
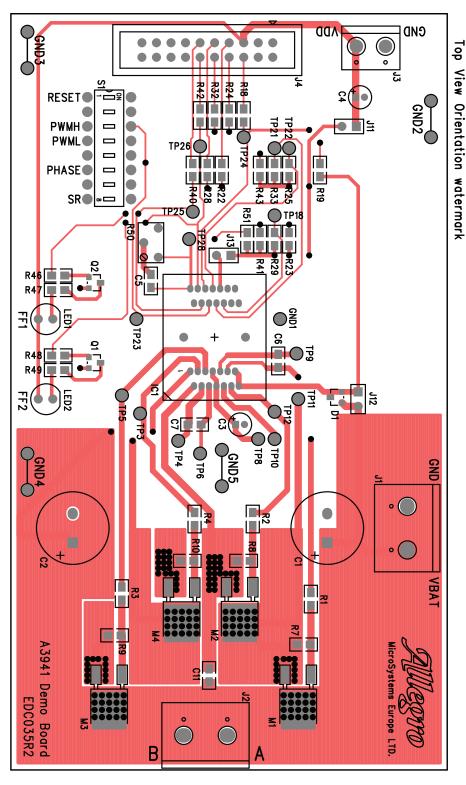


Demo Board Schematic/Layout

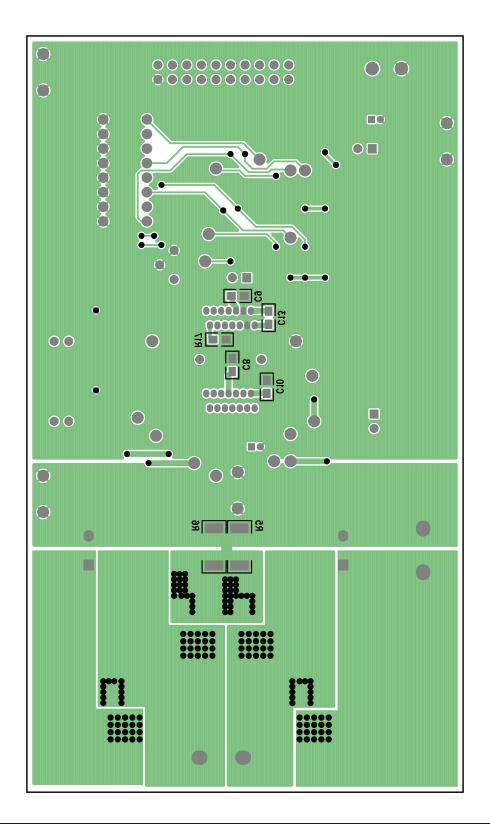
SCHEMATIC



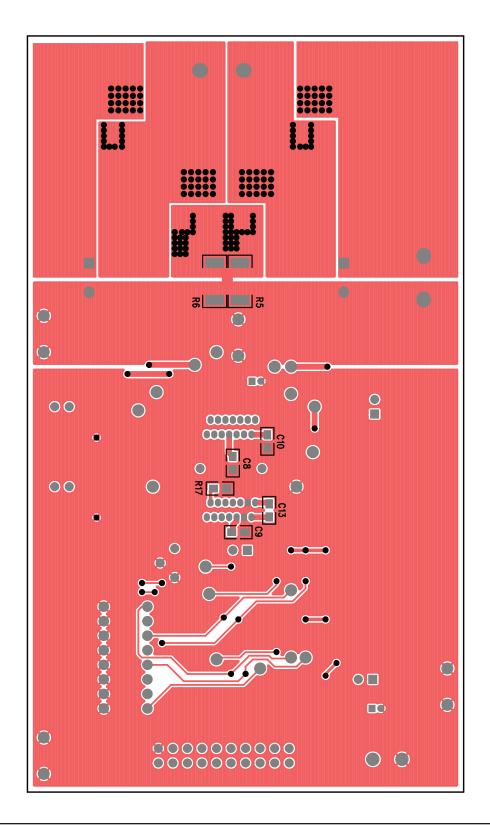
LAYOUT













Demo Board Schematic/Layout

BILL OF MATERIALS

Part	Value	Package	Device	RS Part	Part	Value	Package	Device	RS Part
C1	1,000uF	12.5mm, 5mm pitch	Alu Electrolytic Cap, >=50V, 105C	365-4329	R1	100R	0805	Chip Resistor	223-0297
C2	1,000uF	12.5mm, 5mm pitch	Alu Electrolytic Cap, >=50V, 105C	365-4329	R2	100R	0805	Chip Resistor	223-0297
C3	10uF	4mm dia, 1.5mm pitch	Alu Electrolytic Cap, >=16V, 105C	414-9008	R3	100R	0805	Chip Resistor	223-0297
C4	10uF	4mm dia, 1.5mm pitch	Alu Electrolytic Cap, >=16V, 105C	414-9008	R4	100R	0805	Chip Resistor	223-0297
C5	1nF	0805	Ceramic Chip Cap, >=16V, COG	237-6977	R7	470k	0805	Chip Resistor	223-0786
C6	220nF	0805	Ceramic Chip Cap, >=35V, X5R	624-2604	R8	470k	0805	Chip Resistor	223-0786
C7	220nF	0805	Ceramic Chip Cap, >=35V, X5R	624-2604	R9	470k	0805	Chip Resistor	223-0786
C8	100nF	0805	Ceramic Chip Cap, >=35V, X5R	237-7100	R10	470k	0805	Chip Resistor	223-0786
C9	100nF	0805	Ceramic Chip Cap, >=16V, X5R	237-7100	R17	100k	0805	Chip Resistor	223-0691
C10	100nF	0805	Ceramic Chip Cap, >=50V, X5R	237-7100	R18	1k	0805	Chip Resistor	223-0427
C11	100nF	0805	Ceramic Chip Cap, >=50V, X5R	237-7100	R19	27k	0805	Chip Resistor	223-0613
C13	470nF	0805	Ceramic Chip Cap, >=25V, X5R	220-7988	R22	1k	0805	Chip Resistor	223-0427
			· ·		R23	47k	0805	Chip Resistor	223-0641
D1	BAT54	SOT23	Schottky Diode, 0.2A, 30V	436-7818	R24	1k	0805	Chip Resistor	223-0427
			•		R25	47k	0805	Chip Resistor	223-0641
GND1	\	1mm PCB Hole	Test Terminal, Black	262-2179	R28	1k	0805	Chip Resistor	223-0427
GND2-5	\	1.2mm Hole Pairs	Ground Bar, 20swg Tinned Copper Wire*	355-063	R29	47k	0805	Chip Resistor	223-0641
					R32	1k	0805	Chip Resistor	223-0427
IC1	A3941	eTSSOP28 socket	Socket, enplas p/n OTS-28-0.65-01	\	R33	47k	0805	Chip Resistor	223-0641
					R40	1k	0805	Chip Resistor	223-0427
J1	\	7.62mm (300mil) pitch	Screw Terminal, 2-way	189-5966	R41	3k9	0805	Chip Resistor	223-0506
J2	`	7.62mm (300mil) pitch	Screw Terminal, 2-way	189-5966	R42	1k	0805	Chip Resistor	223-0427
J3	ì	5.08mm (200mil) pitch	Screw Terminal, 2-way	425-8720	R43	3k9	0805	Chip Resistor	223-0506
J4	`	2x10pins, 100mils pitch	IDC Ribbon Header, 20-way	542-9024	R46	47k	0805	Chip Resistor	223-0641
J11	\	2x1mm, 2.54mm pitch	Jumper 2.54mm (Default Open)	251-8503	R47	2k2	0805	Chip Resistor	223-0477
J12	\	2x1mm, 2.54mm pitch	Jumper 2.54mm (Default Closed)	251-8503	R48	47k	0805	Chip Resistor	223-0641
J13	\	2x1mm, 2.54mm pitch	Jumper 2.54mm (Default Closed)	251-8503	R49	2k2	0805	Chip Resistor	223-0477
010	1	ZXTIIIII, Z.O-IIIII pitori	damper 2.54mm (Belauk Glosea)	201 0000	R50	50k	6mm	Multiturn Trim Resistor	521-9293
LED1	1	3mm	LED, Red, 20mA	228-4979	R51	10k	0805	Chip Resistor	223-0562
LED2	1	3mm	LED, Red, 20mA	228-4979	1131	TOK	0003	Only Hesistor	223-0302
LEDZ	1	311111	LLD, Nea, ZolliA	220-4373	S1	8-Way	DIL-16	8-pole DIP Switch	342-118
M1	IRFR2405PbF	DPAK (TO252AA)	MOSFET, 56A, 55V	543-2222	31	o-way	DIL-10	6-pole DIF Switch	342-110
M2	IRFR2405PbF	DPAK (TO252AA)	MOSFET, 56A, 55V	543-2222	TPx (x17)	1	1mm PCB Hole	Test Terminal, Red	262-2185
M3	IRFR2405PbF	DPAK (TO252AA)	MOSFET, 56A, 55V	543-2222	1FX (X17)	١	IIIIIII FOB Hole	rest reminal, neu	202-2100
M4	IRFR2405PbF	DPAK (TO252AA)	MOSFET, 56A, 55V	543-2222	0	A - -	Desistant Management	(NI-tt li-l	>
IVI4	INFR2405F0F	DPAK (10252AA)	MOSFET, 56A, 55V	343-2222	Optional	- Add Sense	Hesistors if required	(Note:cut link under R5 to use sense resist	ors)
PCB	EDC035R2	\	A3941 Demo Board Rev2 PCB	\	R5	R022	2512 6.4x3.2mm	1W Chip Resistor	294-5602
-					R6	R022	2512 6.4x3.2mm	1W Chip Resistor	294-5602
Q1	BC817	SOT23	NPN Bipolar Transistor	484-2252					
Q2	BC817	SOT23	NPN Bipolar Transistor	484-2252					
					\	\	\	Jumper Shorting Link (Red, x3/board)	251-8531
					\	\	\	Rubber Feet (x5/board)	248-451

- BOARD BUILD NOTES:

 (1) Jumper shorting link = Fit x3 per board.

 (2) "Ground bar = 20swg Tinned Copper Wire, Approx 10mm Height, Square Corner Formed (see pic):
 (3) Rubber Feet = Fit x5 per board, one in each corner and one near socket (as near as possible).

 (4) Final 'active' stage = board wash (no flux present on finished boards).

 (5) No manufacturer stick-on label's on topside of pcb, bottom side only.

 (6) PCB to have a smooth routed finish with no breakout 'lugs' remaining.





A3921

Demo Board Schematic/Layout

Revision History

Number	Date	Description
_	September 13, 2016	Initial release

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